EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	29	("20010000684" | "20040250989" | "20050201063" | "20050276021" | "20060056154" | "20060139891" | "4825337" | "5680295" | "5161087" | "5966287" | "6130820" | "6278610" | "6707673" | "6775139" | "6888719" | "6119765" | "6188576" | "6233150" | "6266244" | "6424532" | "6466441" | "6535387" | "7187552" | "7312996" | "7349219" | "7349220" | "7365985" | "7400506" | "7403383").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 16:55
S2	1397	361/697.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 16:59
S3	0	S2 ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:00
S4	0	361/704.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:00
S5	0	361/715-716.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:00
S6	1	361/719.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:00

S7	0	361/717.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:00
S8	0	361/729.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:00
S9	0	361/748.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:01
S10	0	165/80.3.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:01
S11	0	165/185.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:01
S12	0	439/485.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:01
S13	0	439/487.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:01
S14	1	257/675.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:01
S15	9	"361"/$.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:01
S16	1	"165"/$.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:02
S17	32	"257"/$.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:02
S18	2	"439"/$.ccls. ((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:03

S19	712	((power or semiconductor) (tilt with plate) heat$3 memory)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:03
S20	78	S19 (memory near2 (unit or modul$3))	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:03
S21	53	S20 cool$3	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:03
S22	43	S21 (pivot$4 or rotat $4)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:04
S23	37	S22 ((heat or cool) near2 (sink or plate))	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:04
S24	0	S23 (((heat or cool) near2 (sink or plate)) with (tilt or pivot$4 or rotat$4))	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:05
S25	58	"361"/$.ccls. ((RAM or (memory near2 (modul $3 or unit))) (((heat or cool) near2 (sink or plate)) with (tilt or pivot $4 or rotat$4)))	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/28 17:05
S26	11	("20030026076" | "20050276021" | "5109318" | "5815371" | "5966287" | "6119765" | "6233150" | "6535387" | "7079396" | "7221569").PN. OR ("7349220").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/28 17:24
S27	0	(10/776680).APP.	USPAT; USOCR	AND	ON	2009/04/29 09:31
S28	7	("5161087" | "5764482" | "6088228" | "6188576").PN. OR ("6278610").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 09:53

S29	29	("4858070" | "4916575" | "5594204" | "5596486" | "5608610" | "5657203" | "5671122" | "5703754" | "5731633").PN. OR ("6188576").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 09:54
S30	269	"361"/$.ccls. ((DIMM or RAM OR SIP or (memory near "2" (unit or modul$3))) ((heat or cool) near2 (sink or plate)) (axis or hinge))	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 10:04
S31	240	S30 (PCB or board or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/29 10:12
S32	81	S31 (plug or insert)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/29 10:12
S33	58	"165"/$.ccls. ((SIMM OR DIMM or RAM OR SIP or (memory near "2" (unit or modul$3))) ((chip or IC or semiconductor or memory) with (heat or cool)) ((sink or plate or cool$3 or body or dissipat$3) with (axis or hinge)))	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 10:19
S34	103	"257"/$.ccls. ((SIMM OR DIMM or RAM OR SIP or (memory near "2" (unit or modul$3))) ((chip or IC or semiconductor or memory) with (heat or cool)) ((sink or plate or cool$3 or body or dissipat$3) with (axis or hinge)))	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 10:30

S35	90	"361"/$.ccls. ((SIMM OR DIMM or RAM OR SIP or (memory near "2" (unit or modul$3))) ((chip or IC or semiconductor or memory) with (heat or cool)) ((sink or plate or cool$3 or body or dissipat$3) with (axis or hinge)))	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 10:43
S36	0	((SIMM OR DIMM or RAM OR SIP or (memory near "2" (unit or modul$3))) ((chip or IC or semiconductor or memory) with (heat or cool)) ((sink or plate or cool$3 or body or dissipat$3) with (axis or hinge)))	EPO; JPO; DERWENT	AND	ON	2009/04/29 10:44
S37	623	((SIMM OR DIMM or RAM OR SIP or (memory near "2" (unit or modul$3))) ((chip or IC or semiconductor or memory) with (heat or cool)) ((sink or plate or cool$3 or body or dissipat$3) with (axis or hinge)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:00
S38	443	S37 ((chip or IC or semiconductor or memory) with (sink or plate or cool$3 or body or dissipat$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:04
S39	337	S38 ((heat or cool) near4 (sink or plate or cool$3 or body or dissipat$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:04
S40	1	S39 ((insert or plug) with (SIMM OR DIMM or RAM OR SIP or (memory near "2" (unit or modul $3))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:06

S41	17	"361"/$.ccls. ((board or PCB or substrate) strip ((insert or plug) with (SIMM OR DIMM or RAM OR SIP or (memory near "2" (unit or modul $3)))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:07
S42	120	"361"/$.ccls. ((board or PCB or substrate) ((insert or plug) with (SIMM OR DIMM or RAM OR SIP or (memory near "2" (unit or modul $3)))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:10
S43	46	S42 (heat or cool)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:10
S44	18889	(((heat or cool) near3 (sink or plate or body)) (SIMM OR DIMM or RAM OR DRAM OR SIP or ((semiconductor or memory) near2 (unit or modul$3))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:15
S45	9180	S44 ((PCB or board or substrate) contact)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:15
S46	1943	S45 ((tilt or axis or pivot$4 or rotat$4) with (sink or plate or body))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:17
S47	552	S46 hinge	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:17
S48	44	S47 ("361"/$.ccls or "165"/$.ccls. or "174"/ $.ccls. or "257"/$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:20
S49	0	"174"".16.""3".ccls. (((heat or cool) near3 (sink or plate or body)) (SIMM OR DIMM or RAM OR DRAM OR SIP or ((semiconductor or memory) near2 (unit or modul$3))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:22

S50	150	174/16.3.ccls.(((heat or cool) near3 (sink or plate or body)) (SIMM OR DIMM or RAM OR DRAM OR SIP or ((semiconductor or memory) near2 (unit or modul$3))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:23
S51	109	S50 ((PCB or board or substrate) contact)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:23
S52	22	S51 ((tilt or axis or pivot$4 or rotat$4) with (sink or plate or body))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:24
S53	614	"174"/$.ccls.(((heat or cool) near3 (sink or plate or body)) (SIMM OR DIMM or RAM OR DRAM OR SIP or ((semiconductor or memory) near2 (unit or modul$3))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:30
S54	129	S53 (plug or insert)	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/29 11:30
S55	112	S54 contact	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/29 11:30
S56	9	S55 hinge	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/29 11:30
S57	12	"361"/$.ccls. ((memory near2 (strip or modul$3)) ((insert or plug) with (PCB or board or substrate or strip)) ((tilt or axis or pivot$4 or rotat$4 or hinge) with (sink or plate or body)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:32

S58	7	"257"/$.ccls. ((memory near2 (strip or modul$3)) ((insert or plug) with (PCB or board or substrate or strip)) ((tilt or axis or pivot$4 or rotat$4 or hinge) with (sink or plate or body)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:33
S59	3	"165"/$.ccls. ((memory near2 (strip or modul$3)) ((insert or plug) with (PCB or board or substrate or strip)) ((tilt or axis or pivot$4 or rotat$4 or hinge) with (sink or plate or body)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:33
S60	2	"174"/$.ccls. ((memory near2 (strip or modul$3)) ((insert or plug) with (PCB or board or substrate or strip)) ((tilt or axis or pivot$4 or rotat$4 or hinge) with (sink or plate or body)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:34
S61	100	((memory near2 (strip or modul$3)) ((insert or plug) with (PCB or board or substrate or strip)) ((tilt or axis or pivot$4 or rotat$4 or hinge) with (sink or plate or body)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:34
S62	89	S61 contact	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:35
S63	13	((cool near2 plate) (memory near2 module)) ("361"/$.ccls or "165"/$.ccls. or "174"/$.ccls. or "257"/$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 11:47

S64	11	("20030026076" | "20050276021" | "5109318" | "5815371" | "5966287" | "6119765" | "6233150" | "6535387" | "7079396" | "7221569").PN. OR ("7349220").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 11:52
S65	20	"5966287"	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 12:18
S66	1	"5966287".pn.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 12:18
S67	0	(10/776680).APP.	USPAT; USOCR	AND	ON	2009/04/29 12:30
S68	37	foxconn.as. (memory near2 module)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 12:53
S69	15	("20030026076" | "20070195489" | "20070206359" | "20070217160" | "3506877" | "5109318" | "5966287" | "6119765" | "6233150" | "6297966" | "6765797" | "7221569" | "7349220" | "7375964").PN. OR ("7457122").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 13:13
S70	11	("20030026076" | "20050276021" | "5109318" | "5815371" | "5966287" | "6119765" | "6233150" | "6535387" | "7079396" | "7221569").PN. OR ("7349220").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 13:16
S71	4967	(((memory or semiconductor or chip or IC) near2 module) ((heat or cool or dissipat$3) with (sink or plate or body))) ("361"/$.ccls or "165"/$.ccls. or "174"/$.ccls. or "257"/$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 13:24

S72	61	S71 ((pivot$4 or rotat$4 or tilt) with (join$4 or axis or hinge) with (sink or plate or body))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	AND	ON	2009/04/29 13:26
S73	7	("5161087" | "5764482" | "6088228" | "6188576").PN. OR ("6278610").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 13:27
S74	1	"7215551".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/29 14:25
S75	2	US "20060067054"	US-PGPUB; USPAT; USOCR; EPO; JPO	AND	ON	2009/04/29 14:26
S76	7	("20060056160" | "6535387" | "6775139" | "7023700" | "7079396").PN. OR ("7312996").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 14:35
S77	18	("20070139897" | "3893161" | "4872505" | "5109318" | "5513135" | "5784263" | "5901781" | "6173382" | "6208517" | "6278610" | "6424532" | "6507912" | "6510100" | "6535387" | "7079396" | "7106595" | "7312996" | "7403383").PN. OR ("7474529").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 14:36
S78	18	("20040161953" | "20070053170" | "20070064401" | "20070121286" | "4935845" | "5410448" | "5528455" | "6198629" | "6285548" | "6512672" | "6738262" | "6744632" | "6785142" | "6920050" | "7092252" | "7269006" | "7280356").PN. OR ("7403383").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 14:36

S79	15	("20030026076" | "20070195489" | "20070206359" | "20070217160" | "3506877" | "5109318" | "5966287" | "6119765" | "6233150" | "6297966" | "6765797" | "7221569" | "7349220" | "7375964").PN. OR ("7457122").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 14:38
S80	24	("3187087" | "3798506" | "4027206" | "4625260" | "4707726" | "5208729" | "5228192" | "5276584" | "5370517" | "5567986" | "5684675" | "5719745" | "5751553" | "5757073" | "5779134" | "5808417" | "5831847" | "6000132" | "6020661" | "6201695" | "6319756" | "6449161").PN. OR ("6707673").URPN.	US-PGPUB; USPAT; USOCR	AND	ON	2009/04/29 15:39

4/29/2009 5:35:42 PM
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